The Inspur i24 high-density platform integrates extreme performance and workload capability in a compact 2U chassis. Its top-tier compute density and flexible configuration makes it the ideal platform for Hyperscale Infrastructure, Cloud Computing and HPC.

Specifications

- **Dimensions**: 3.5” Drives: 17.6in*3.4 inch*33.3in  
  2.5” Drives: 17.6in*3.4in*31.7in
- **CPU**: 2*Skylake CPU TDP up to 165W (per node)
- **Chipset**: Intel® C620 series chipset
- **Memory**: 16*DIMMs per node
- **Storage**:  
  • Optional 3*3.5” SATA/SAS (direct attach) (per node)  
  • Optional 6*2.5” SATA/SAS (direct attach) (per node)  
  • Optional 2*2.5” SATA/SAS + 4*U.2 (direct attach) (per node)
- **Expansion slot**: Optional 6*NVMe SSD (per node)
- **Integrated I/O port**: 2*HHHL x16 PCIE slot (per node)
- **Network**: 1*OCP or PHY NIC Mezz (per node)
- **Power Supply**: High-density connector (2*USB 3.0 + 1*VGA + 1*RS232) (per node)  
  Integrated or OCP NIC (per node)  
  Supports platinum/titanium power supply
- **Management**: Single or Dual Power Supply options
- **Supported OS**: Supports PMBUS
- **Operating Temperature Range**: IPMI 2.0 compliant with AST 2500  
  Linux and Windows  
  10°C - 35°C

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